COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: Final TIDA-00688

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA-00688</th>
<th>REV:</th>
<th>SVN REV: Not In VersionControl</th>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 08.12.2015 10:27:48</td>
<td>TEXAS INSTRUMENTS</td>
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